

CMOS Quad **True/Complement Buffer**

High Voltage Types (20-Volt Rating)

■ CD4041UB types are guad true/ complement buffers consisting of n- and p-channel units having low channel resistance and high current (sourcing and sinking) capability. The CD4041UB is intended for use as a buffer, line driver, or CMOS-to-TTL driver, it can be used as an ultra-low power resistor-network driver for A/D and D/A conversion, as a transmission-line driver, and in other applications where high noise immunity and low power dissipation are primary design requirements.

I ne CD4041UB types are supplied in 14-lead hermetic dual-in-line ceramic packages (D and F suffixes), 14-lead dual-in-line plastic packages (E suffix), 14-lead ceramic flat packages (K suffix), and in chip form (H suffix).

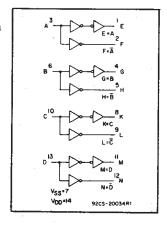
CD4041UB Types

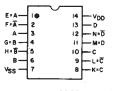
Features:

- Balanced sink and source current; approximately 4 times standard "B" drive
- Equalized delay to true and complement outputs
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μ A at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications:

- High current source/sink driver
- CMOS-to-DTL/TTL Converter Buffer
- Display driver
- MOS clock driver
- Resistor network driver (Ladder or weighted R)
- **Buffer**
- Transmission line driver





92CS-20755R1

TOP VIEW TERMINAL ASSIGNMENT

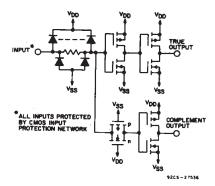


Fig.1 - Schematic diagram 1 of 4 buffers.

MAXIMUM RATINGS, Absolute-Maximum Values:

| DC SUPPLY-VOLTAGE RANGE, (VDD) | |
|--|--------------------------------------|
| Voltages referenced to VSS Terminal) | |
| INPUT VOLTAGE RANGE, ALL INPUTS | +0.5V |
| DC INPUT CURRENT, ANY ONE INPUT | ±10mA |
| POWER DISSIPATION PER PACKAGE (PD): | |
| For T _A = -55°C to +100°C | 500mW |
| For T _A = +100°C to +125°C | Derate Linearity at 12mW/°C to 200mW |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR | • |
| FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Package | Types)100mW |
| OPERATING-TEMPERATURE RANGE (TA) | |
| STORAGE TEMPERATURE RANGE (Tstg) | |
| LEAD TEMPERATURE (DURING SOLDERING): | |
| At distance 1/16 \pm 1/32 inch (1.59 \pm 0.79mm) from case for 10s m | nax+265°C |

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following range:

| CHARACTERISTIC | LIN | UNITS | |
|--|------|-------|---|
| | Min. | Max. | |
| Supply-Voltage Range (For TA=Full Package- Temperature Range) | 3 | 18 | ٧ |

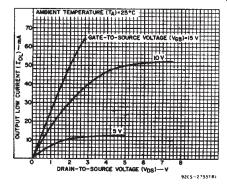


Fig.2 - Typical output low (sink) current characteristics.

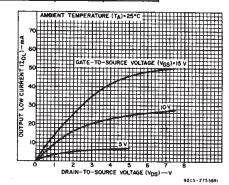


Fig.3 - Minimum low (sink) current characteristics.

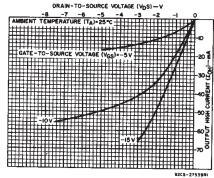


Fig.4 - Typical output high (source) current characteristics.

CD4041UB Types

STATIC ELECTRICAL CHARACTERISTICS

| | | | | | | · | | | | 1.44.5 |
|----------------|-----------|---|--|---|---|---|---|---|--|----------------|
| | | | | | | | | | Ş | |
| CONE | OITION | ıs | LIM | LIMITS AT INDICATED TEMPERATURES (°C) | | | | | | UNITS |
| v _o | VIN | V_{DD} | +25 | | | | | |] | |
| (V) | (V) | (V) | –55 | 40 | +85 | +125 | Min. | Тур. | Max. | |
| - | 0,5 | 5 | 1 | 1 | 30 | 30 | | 0.02 | . 1 | |
| | 0,10 | 10 | 2 | 2 | 60 | 60 | _ | 0.02 | 2 | μΑ |
| | 0,15 | | 4 | . 4 | 120 | | - - | 0.02 | 4 | |
| <u> </u> | 0,20 | 20 | 20 | 20 | 600 | 600 | _ | 0.04 | 20 | |
| | | | | | | | | | | |
| | | _ | | | 1.3 | | | 3.2 | | |
| | 0,10 | | | | 4 | 3.5 | . 5 | 10 | | |
| | 0,15 | | 24 | | 15.5 | 13 | | | - , | mA |
| 4.6 | 0,5 | 5 | -2.1 | -1.8 | -1.3 | -1.2 | -1.6 | -3.2 | = | '''' |
| 2.5 | 0,5 | 5 | -8.4 | -6.7 | -5.3 | -4 .6 | -6.4 | -12.8 | _ | |
| 9.5 | 0,10 | 10 | -6.25 | -5.6 | -4 | -3.5 | -5 | -10 | - | |
| 13.5 | 0,15 | 15 | -24 | -23 | -15.5 | -13 | -19 | -38 | _ | |
| | | | | | | | | | | |
| . – | 0,5 | 5 | | 0.05 | | | | 0 | 0.05 | |
| - | 0,10 | 10 | | 0.05 | | | _ | 0 | 0.05 | |
| | 0,15 | 15 | | 0.05 | | | - | 0 | 0.05 | l _v |
| | | | | | | | | | | 1 * |
| | 0,5 | 5 | | 4.95 | | | | 5 | _ | |
| _ | 0,10 | 10 | | 9.95 | | | 9.95 | 10 | _ | |
| _ | 0,15 | 15 | | 14.95 | | | 14.95 | 15 | - | |
| 0.5,4.5 | _ | 5 | | -1 | | | - | _ | 1 | |
| 1,9 | _ | 10 | | 2 2.5 | | | - | | 2 |] |
| 1.5,13.5 | - | 15 | | | | | _ | - | 2.5 | l v |
| 0.5,4.5 | | 5 | 4 8 12.5 | | | 4 | _ | - | | |
| 1,9 | - | 10 | | | | 8 | _ | _ | | |
| 1.5,13.5 | _ | 15 | | | | 12.5 | _ | _ | | |
| | | | | 150 | | | | _ | 1 | |
| - | 0,18 | 18 | ±0.1 | ±0.1 | | ±1 | - | ±10 ⁻⁵ | ±0.1 | μΑ |
| I | | · ' | I | Ī | 1 | 1 | i . | I | ı | 1 |
| | VO (V) | VO (V) (V) - 0,5 - 0,10 - 0,15 - 0,20 0.4 0,5 0.5 0,10 1.5 0,15 4.6 0,5 2.5 0,5 9.5 0,10 13.5 0,15 - 0,5 - 0,10 - 0,15 - 0,5 - 0,10 - 0,15 0.5,4.5 - 1,9 1.5,13.5 - 0.5,4.5 - 1,9 1.5,13.5 - 1,9 1.5,13.5 - | (V) (V) (V) - 0,5 5 - 0,10 10 - 0,15 15 - 0,20 20 0.4 0,5 5 0.5 0,10 10 1.5 0,15 15 4.6 0,5 5 2.5 0,5 5 9.5 0,10 10 13.5 0,15 15 - 0,15 15 - 0,10 10 - 0,15 15 - 0,10 10 - 0,15 15 0.5,4.5 - 5 1,9 - 10 1.5,13.5 - 15 0.5,4.5 - 5 1,9 - 10 1.5,13.5 - 15 | VO (V) V _{IN} (V) V _{DD} (V) -55 - 0,5 5 1 - 0,10 10 2 - 0,15 15 4 - 0,20 20 20 0.4 0,5 5 2.1 0.5 0,10 10 6.25 1.5 0,15 15 24 4.6 0,5 5 -2.1 2.5 0,5 5 -2.1 2.5 0,5 5 -8.4 9.5 0,10 10 -6.25 13.5 0,15 15 -24 - 0,15 15 -24 - 0,15 15 -24 - 0,15 15 -24 - 0,15 15 -24 - 0,15 15 -24 - 0,15 15 -24 - 0,15 15 -24 | VO (V) VIN (V) VDD (V) -55 -40 - 0,5 5 1 1 - 0,10 10 2 .2 - 0,15 15 4 .4 - 0,20 20 20 20 0.4 0,5 5 2.1 1.8 0.5 0,10 10 6.25 5.6 1.5 0,15 15 24 23 4.6 0,5 5 -2.1 -1.8 2.5 0,5 5 -2.1 -1.8 2.5 0,5 5 -8.4 -6.7 9.5 0,10 10 -6.25 -5.6 13.5 0,15 15 -24 -23 - 0,10 10 -6.25 -5.6 13.5 0,15 15 -24 -23 - 0,15 15 0.6 - 0,15 15 0.6 | VO (V) VIN (V) VDD (V) -55 -40 +85 - 0,5 5 1 1 30 - 0,10 10 2 .2 60 - 0,15 15 4 4 120 - 0,20 20 20 20 600 0.4 0,5 5 2.1 1.8 1.3 0.5 0,10 10 6.25 5.6 4 1.5 0,15 15 24 23 15,5 4.6 0,5 5 -2.1 -1.8 -1.3 2.5 0,5 5 -2.1 -1.8 -1.3 2.5 0,5 5 -2.1 -1.8 -1.3 2.5 0,5 5 -2.1 -1.8 -1.3 2.5 0,5 5 -8.4 -6.7 -5.3 9.5 0,10 10 -6.25 -5.6 -4 13.5 | VO (V) V _{IN} (V) V _{DD} (V) -55 -40 +85 +125 - 0,5 5 1 1 30 30 - 0,10 10 2 .2 60 60 - 0,15 15 4 .4 120 120 - 0,20 20 20 20 600 600 0.4 0,5 5 2.1 1.8 1.3 1.2 0.5 0,10 10 6.25 5.6 4 3.5 1.5 0,15 15 24 23 15,5 13 4.6 0,5 5 -2.1 -1.8 -1.3 -1.2 2.5 0,5 5 -2.1 -1.8 -1.3 -1.2 2.5 0,5 5 -2.1 -1.8 -1.3 -1.2 2.5 0,5 5 -8.4 -6.7 -5.3 -4.6 9.5 0,15 | VO (V) Vin (V) VDD (V) -55 -40 +85 +125 Min. - 0,5 5 1 1 30 30 - 0,10 10 2 ,2 60 60 - 0,15 15 4 ,4 120 120 - 0,20 20 20 20 600 600 - 0,20 20 20 20 600 600 - 0,20 20 20 600 600 - 0,20 20 20 600 600 - 0,10 10 6.25 5.6 4 3.5 5 1.5 0,15 15 24 23 15.5 13 .19. 4.6 0,5 5 -2.1 -1.8 -1.3 -1.2 -1.6 2.5 0,10 <t< td=""><td>VO (V) VIN (V) VD (V) -55 -40 +85 +125 Min. Typ. - 0,5 5 1 1 30 30 - 0.02 - 0,10 10 2 ,2 60 60 - 0.02 - 0,15 15 4 4 120 120 - 0.02 - 0,20 20 20 600 600 - 0.02 - 0,20 20 20 600 600 - 0.02 - 0,20 20 20 600 600 - 0.02 - 0,20 20 20 600 600 - 0.02 - 0,5 5 2.1 1.8 1.3 1.2 1.6 3.2 0.5 0.15 15 24 23 15,5 13 19. 38 4.6 0,5 5 -</td><td> VO</td></t<> | VO (V) VIN (V) VD (V) -55 -40 +85 +125 Min. Typ. - 0,5 5 1 1 30 30 - 0.02 - 0,10 10 2 ,2 60 60 - 0.02 - 0,15 15 4 4 120 120 - 0.02 - 0,20 20 20 600 600 - 0.02 - 0,20 20 20 600 600 - 0.02 - 0,20 20 20 600 600 - 0.02 - 0,20 20 20 600 600 - 0.02 - 0,5 5 2.1 1.8 1.3 1.2 1.6 3.2 0.5 0.15 15 24 23 15,5 13 19. 38 4.6 0,5 5 - | VO |

DYNAMIC ELECTRICAL CHARACTERISTICS at TA = 25°C, Input t, tf = 20 ns, CL = 50 pF, RL = 200 k Ω

| CHARACTERISTIC | | COND | ITIONS | LII | | |
|-------------------------|------|-----------|--------------------------|------|------|-------|
| | | | V _{DD} Volts | Тур. | Max. | UNITS |
| Propagation Delay Time: | | | 5 | 60 | 120 | |
| tp _H | IL, | | 10 | 35 | 70 | ns |
| tpį | _H | | 15 | 25 | 50 | |
| | THL. | | 5 | 40 | 80 | |
| Transition Lime | | | 10 | 20 | 40 | ns |
| ч | ĿH | | 15 | 15 | 30 | |
| Input Capacitance C | iN | Any Input | | 15 | 22.5 | ρF |

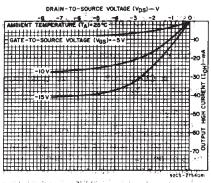


Fig.5 – Minimum output high (source) current characteristics.

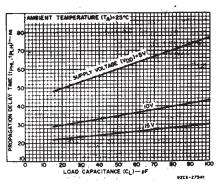


Fig.6 — Typical propagation delay time vs. load capacitance,

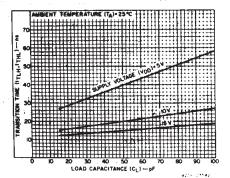


Fig.7 — Typical transition time vs. load capacitance.

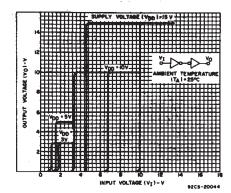


Fig.8 – Minimum and maximum transfer characteristics – true output.

CD4041UB Types

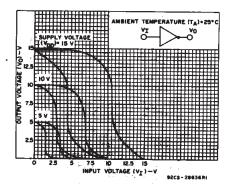


Fig.9 — Minimum and maximum transfer characteristics — complement output,

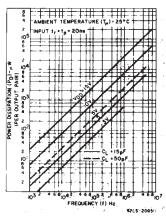


Fig. 11 — Typical power dissipation vs frequency per output pair.

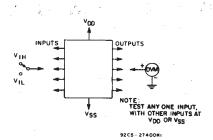


Fig.13 - Input voltage test circuit.

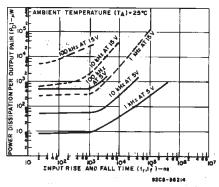


Fig. 10 — Typical power dissipation vs. input rise & fall time per output pair.

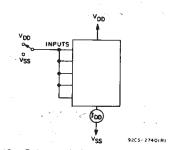


Fig. 12 - Quiescent device current test circuit,

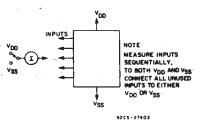
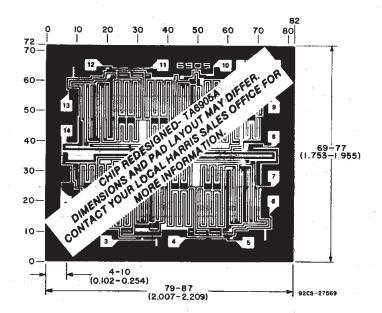


Fig. 14 - Input-leakage-current test circuit.

Dimensions and pad layout for the CD4041UBH



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated Grid graduations are in mils (10^{-3} inch).

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